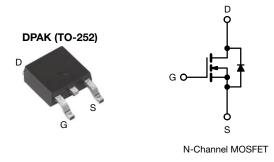
SiHD240N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.208		
Q _g max. (nC)	23			
Q _{gs} (nC)	4			
Q _{gd} (nC)	6			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package DPAK (TO-252)				
Lead (Pb)-free and halogen-free	SiHD240N60E-GE3			
	SiHD240N60E-T1-GE3			
	SiHD240N60E-T4-GE3			
	SiHD240N60E-T5-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	V
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	12	
	VGS AL TU V	T _C = 100 °C		7	А
Pulsed drain current ^a			I _{DM}	30	
Linear derating factor				0.63	W/°C
Single pulse avalanche energy ^b			E _{AS}	81	mJ
Maximum power dissipation			PD	78	W
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	100	1//22	
Reverse diode dv/dt ^d			28	V/ns	
Soldering recommendations (peak temperature)	c	For 10 s		260	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.4 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D, \, di/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-	- 62			°C/W		
Maximum junction-to-case (drain)	R _{thJC}	- 1.6				C/ W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	•	•			•	•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	V _{GS} = 0 V, I _D = 250 μA		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
	_	١	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	Ň	V _{GS} = ± 30	V	-	-	± 1	μA
		V _{DS} =	: 600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V	∕, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	١ _c	₀ = 5.5 A	-	0.208	0.240	Ω
Forward transconductance a	9 _{fs}	V _{DS} =	= 20 V, I _D =	= 5.5 A	-	4	-	S
Dynamic	•	•			•		•	1
Input capacitance	C _{iss}		V _{GS} = 0 V		-	783	-	
Output capacitance	C _{oss}	$V_{GS} = 0.0$ V, $V_{DS} = 100$ V, f = 1 MHz		-	50	-	-	
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	32	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	187	-		
Total gate charge	Qg				-	15	23	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 5.5 A, V _{DS} = 480 V		-	4	-	nC	
Gate-drain charge	Q _{gd}				-	6	-	
Turn-on delay time	t _{d(on)}		•		-	15	30	
Rise time	t _r	V _{DD} =	480 V, I _D =	= 5.5 A,	-	14	28	
Turn-off delay time	t _{d(off)}		= 10 V, R _g =		-	26	52	ns
Fall time	t _f	1			-	14	28	1
Gate input resistance	R _g	f = 1	MHz, oper	n drain	0.8	1.5	3.0	Ω
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12		
Pulsed diode forward current	I _{SM}			-	-	30	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	T _J = 25 °C, I _S = 5.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}				-	209	418	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 5.5 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	2.1	4.2	μC	
Reverse recovery current	I _{RRM}			-	18	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

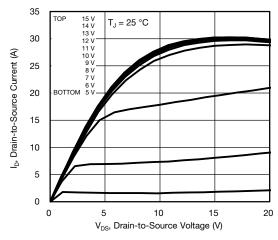
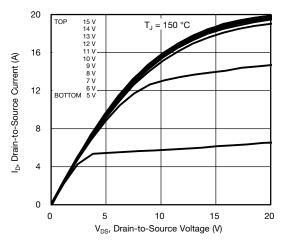


Fig. 1 - Typical Output Characteristics





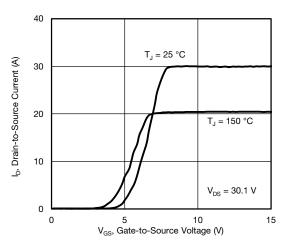


Fig. 3 - Typical Transfer Characteristics

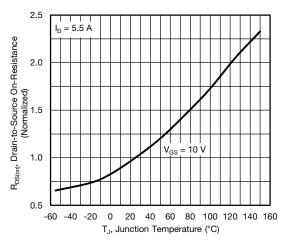


Fig. 4 - Normalized On-Resistance vs. Temperature

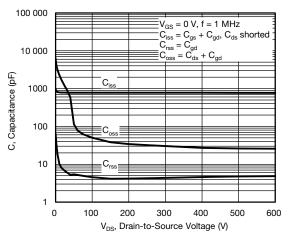


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

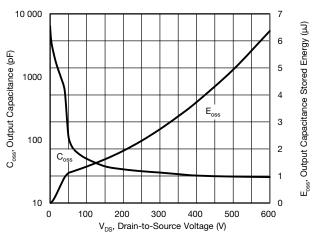


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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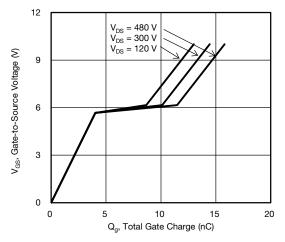


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

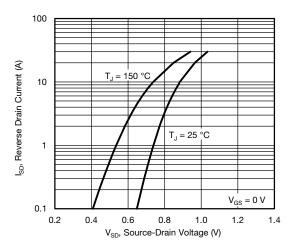


Fig. 8 - Typical Source-Drain Diode Forward Voltage

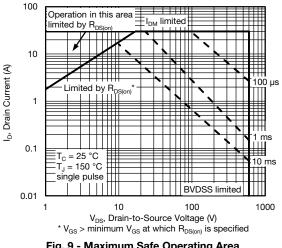


Fig. 9 - Maximum Safe Operating Area

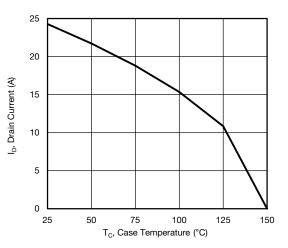


Fig. 10 - Maximum Drain Current vs. Case Temperature

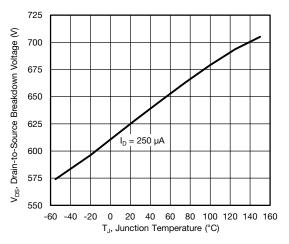
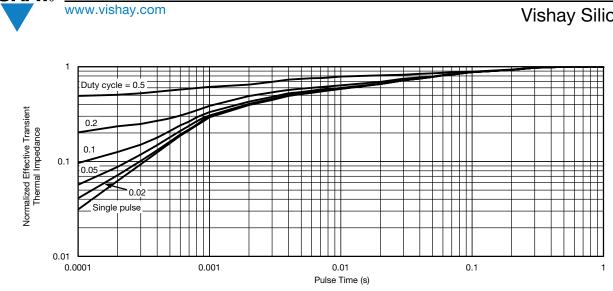


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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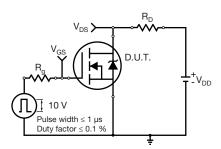


Fig. 13 - Switching Time Test Circuit

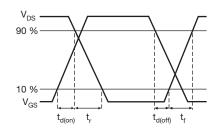


Fig. 14 - Switching Time Waveforms

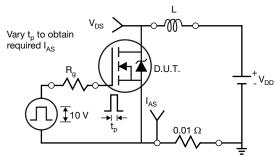
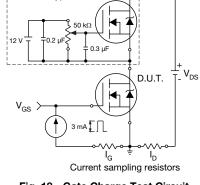


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 17 - Basic Gate Charge Waveform Current regulator Same type as D.U.T

10 V

 V_G



Charge

Fig. 18 - Gate Charge Test Circuit

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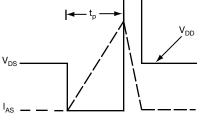
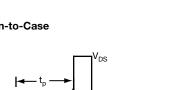
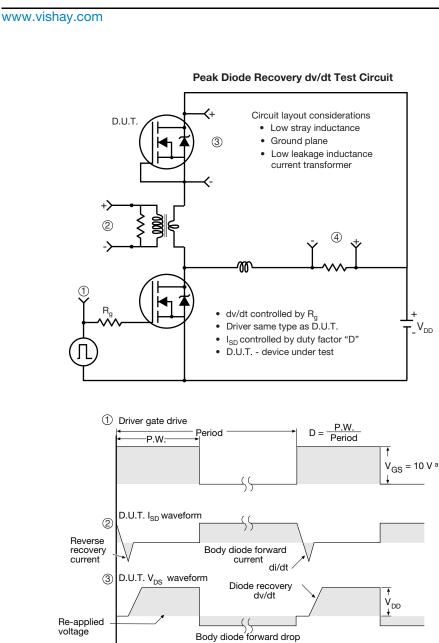


Fig. 16 - Unclamped Inductive Waveforms



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Inductor current

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Note

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Fig. 19 - For N-Channel

Ripple ≤ 5 %

a. $V_{GS} = 5$ V for logic level devices

↑ I_{SD}

SHA

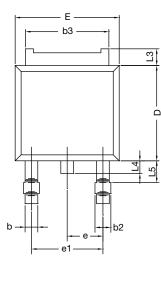
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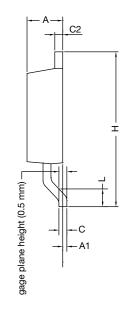


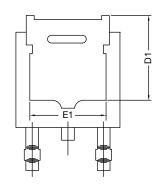


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
A	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

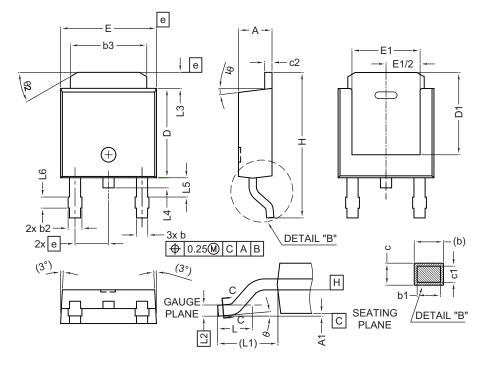
Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
e	2.29 BSC		
Н	9.94 10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74 ref.		
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25° 35°		

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

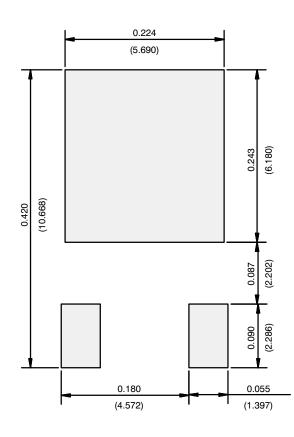
ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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